

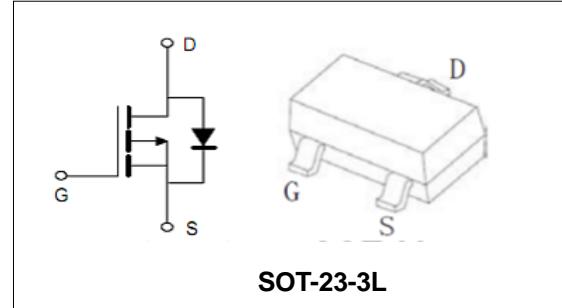
-20V/-6A P-Channel Enhancement Mode MOSFET
Features

- Advanced trench process technology
- High Density Cell Design For Ultra Low On-Resistance

| | | |
|-----------------|-----|----|
| BVDSS | -20 | V |
| ID | -6 | A |
| RDSON@VGS=-4.5V | 17 | mΩ |
| RDSON@VGS=-2.5V | 20 | mΩ |

Applications

- Low Side Load Switch
- Battery Switch
- Optimized for Power Management Applications for Portable Products, such as Aeromodelling, Power bank, Brushless motor, Main board , and Others


Order Information

| Product | Package | Marking | Reel Size | Reel | Carton |
|---------|-----------|---------|-----------|---------|-----------|
| PTL2106 | SOT-23-3L | 2106 | 7inch | 3000PCS | 180000PCS |

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit |
|--|--|------------|------|
| Common Ratings (TC=25°C Unless Otherwise Noted) | | | |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | -20 | V |
| V_{GS} | Gate-Source Voltage | ± 12 | V |
| T_J | Maximum Junction Temperature | 150 | °C |
| T_{STG} | Storage Temperature Range | -55 to 150 | °C |
| I_S | Diode Continuous Forward Current TA =25°C | -6 | A |
| Mounted on Large Heat Sink | | | |
| I_{DM} | Pulse Drain Current Tested (Silicon Limit) (Note1) | TA =25°C | -24 |
| I_D | Continuous Drain current | TA =25°C | -6 |
| P_D | Maximum Power Dissipation | TA =25°C | 1.4 |
| $R_{θJA}$ | Thermal Resistance Junction-to-Ambient (Note2) | 89.2 | °C/W |

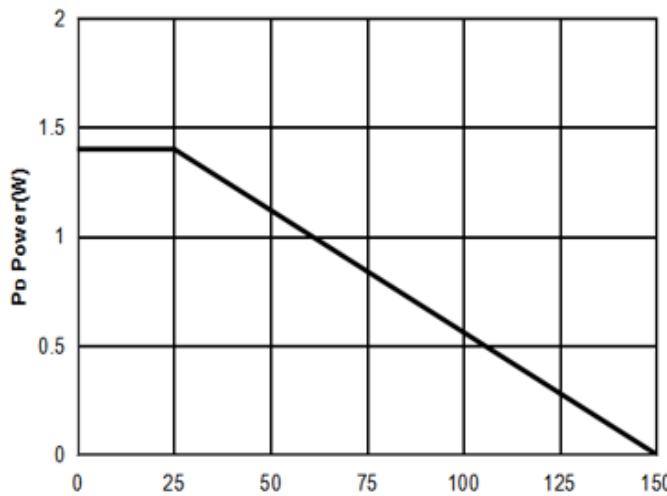
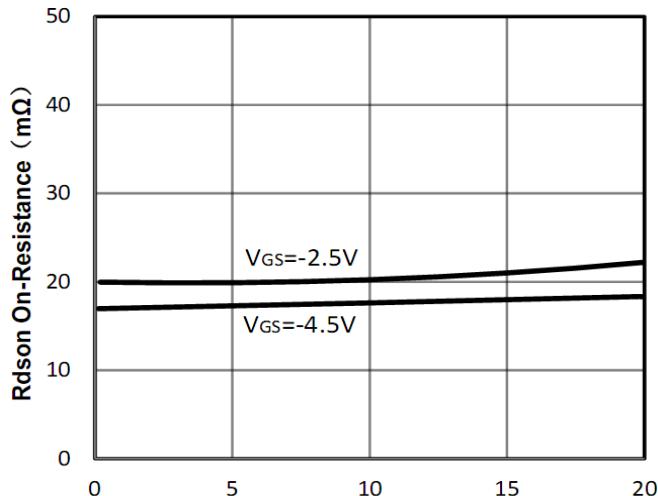
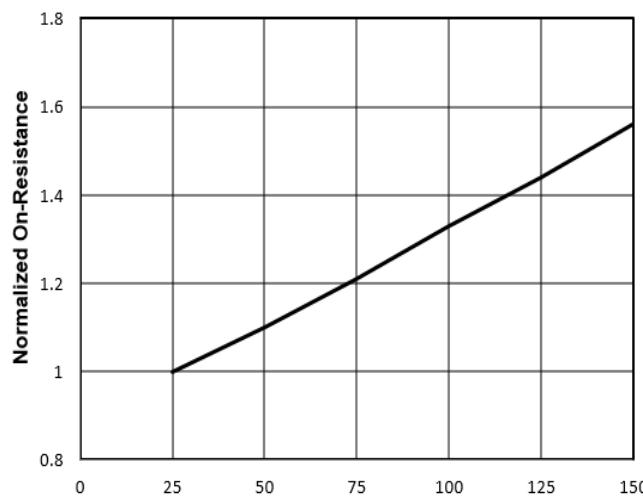
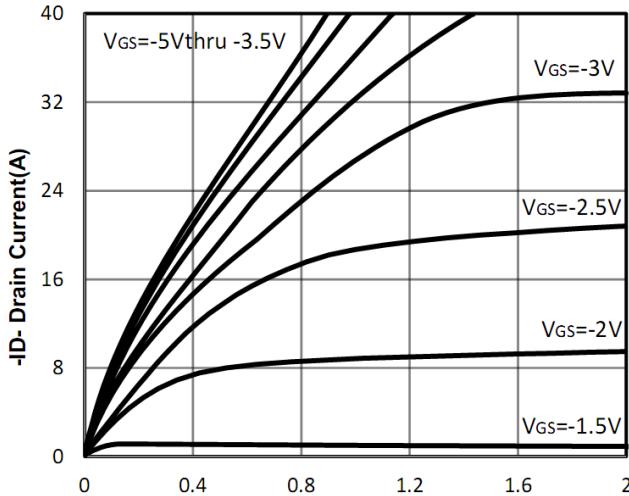
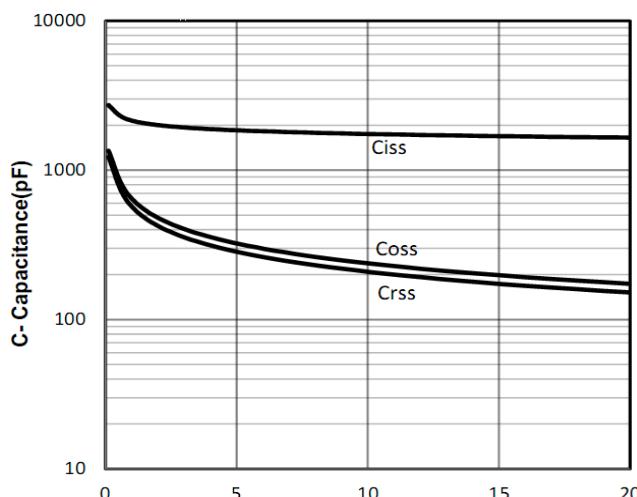
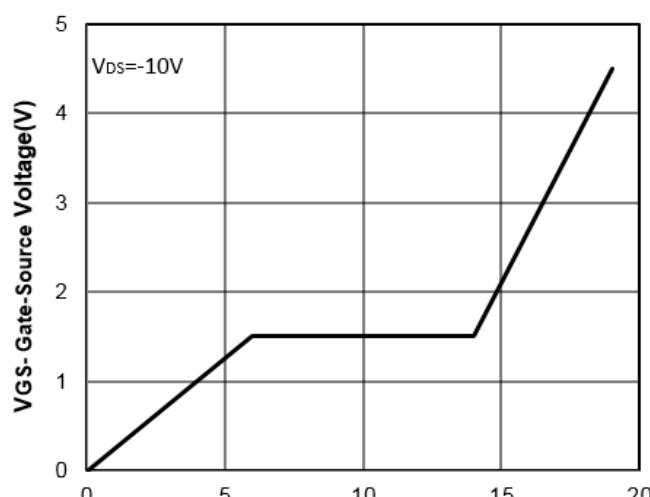


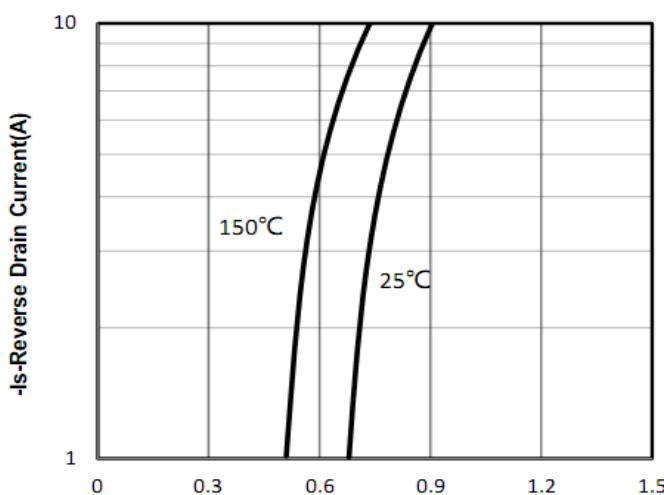
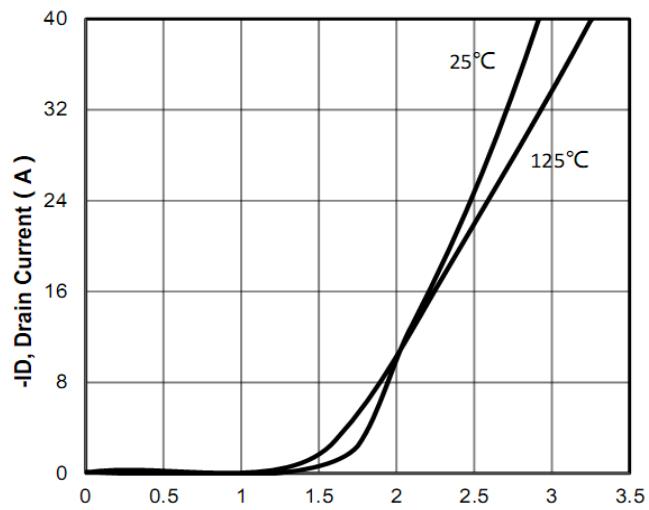
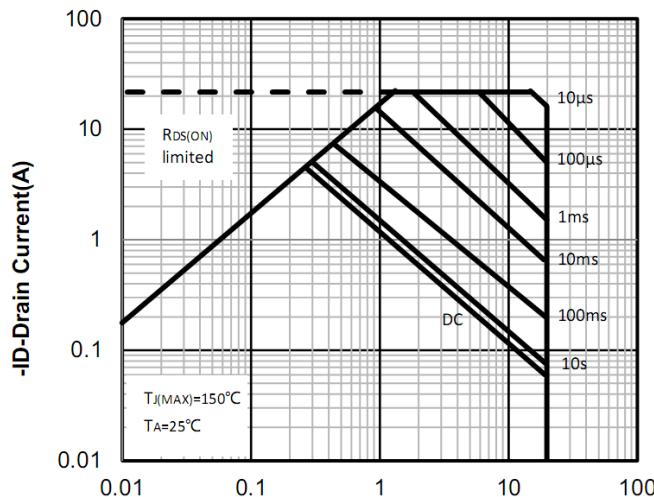
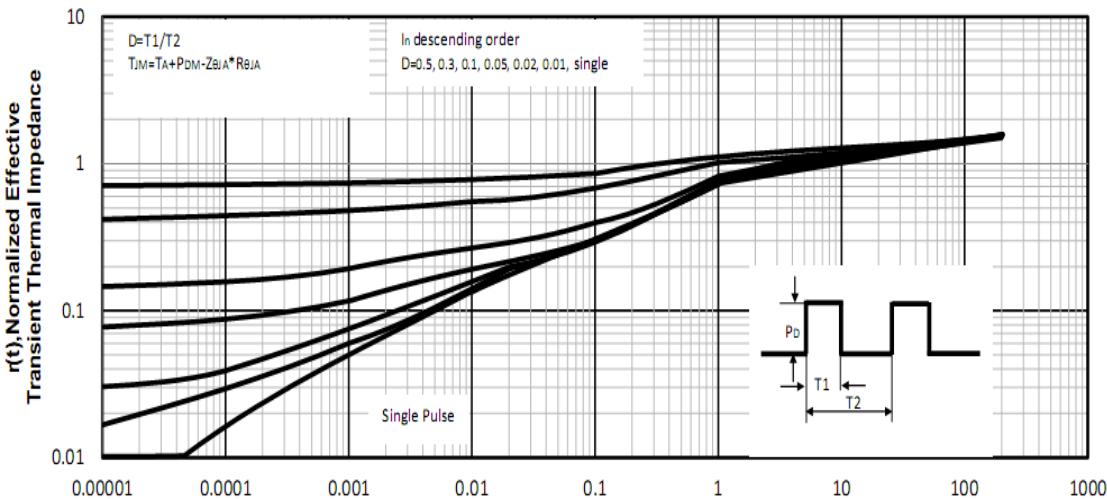
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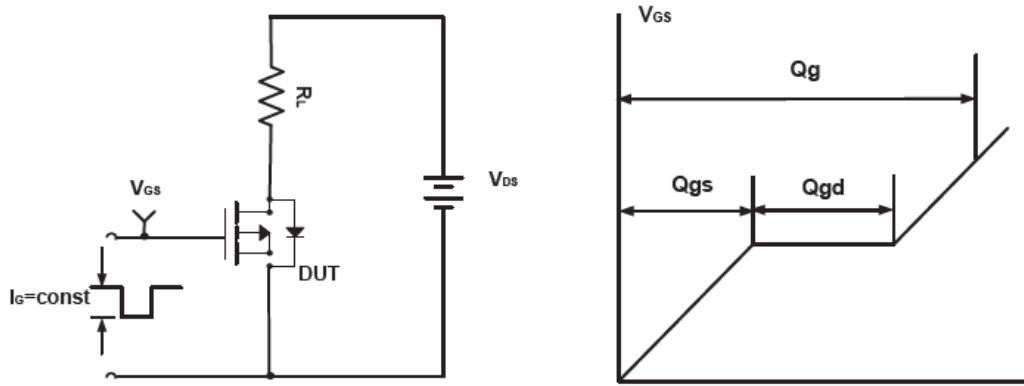
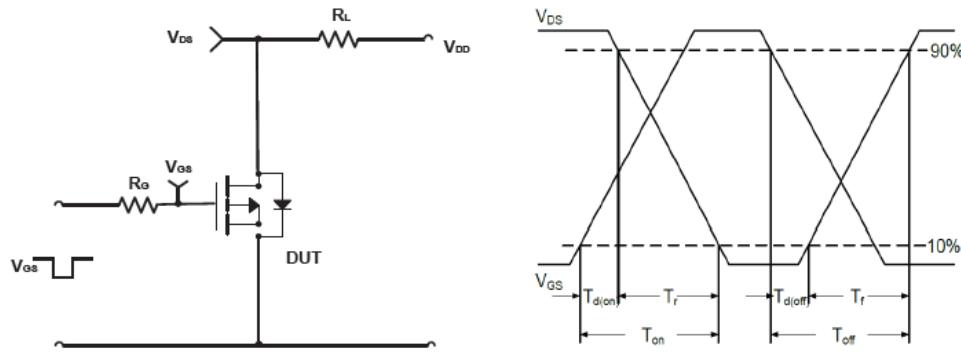
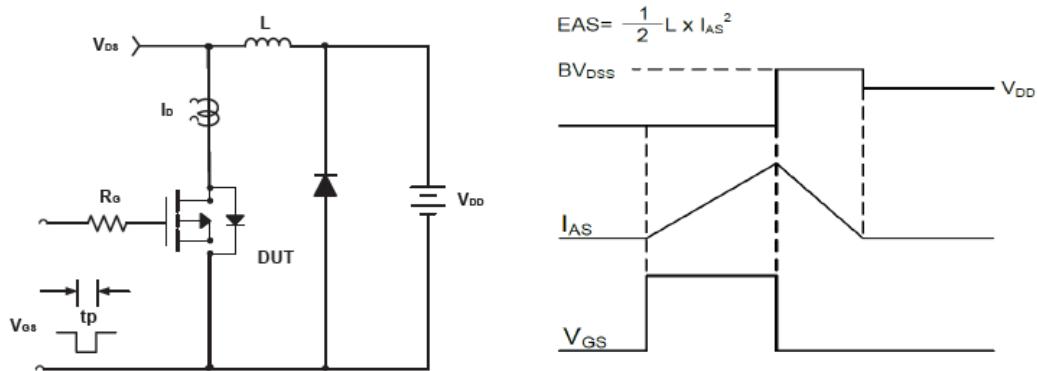
| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|---|--|---|------|------|------|------|
| Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated) | | | | | | |
| V _{(BR)DSS} | Drain- Source Breakdown Voltage | VGS=0V ID=-250µA | -20 | -- | -- | V |
| I _{DSS} | Zero Gate Voltage Drain current | VDS=-20V,VGS=0V | -- | -- | -1 | µA |
| I _{GSS} | Gate-Body Leakage Current | VGS=±12V,VDS=0V | -- | -- | ±100 | nA |
| V _{GS(TH)} | Gate Threshold Voltage | VDS=VGS, ID=-250µA | -0.4 | -- | -1.2 | V |
| R _{DS(ON)} | Drain-Source On-State Resistance (Note3) | VGS=-4.5V, ID=-5.5A | -- | 17 | 25 | mΩ |
| | | VGS=-2.5V, ID=-4A | -- | 20 | 35 | mΩ |
| Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note4) | | | | | | |
| C _{iss} | Input Capacitance | VDS= -10V, VGS=0V, F=1MHz | -- | 1840 | -- | pF |
| C _{oss} | Output Capacitance | | -- | 214 | -- | pF |
| C _{rss} | Reverse Transfer Capacitance | | -- | 207 | -- | pF |
| Q _g | Total Gate Charge | VDS= -10V, ID= -6A, VGS= -4.5V | -- | 19 | -- | nC |
| Q _{gs} | Gate-Source Charge | | -- | 6 | -- | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 8 | -- | nC |
| Switching Characteristics (Note4) | | | | | | |
| t _{d(on)} | Turn-on Delay Time | VDD=-10V, ID=-1A, RG=6Ω, VGS=-4.5V | -- | 25 | -- | nS |
| t _r | Turn-on Rise Time | | -- | 32 | -- | nS |
| t _{d(off)} | Turn-off Delay Time | | -- | 48 | -- | nS |
| t _f | Turn-off Fall Time | | -- | 25 | -- | nS |
| Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated) | | | | | | |
| V _{SD} | Forward on voltage (Note3) | IS=-2.5A,VGS=0V | -- | -- | -1.2 | V |

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec
3. Pulse Test: pulse width ≤ 300 us, duty cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.

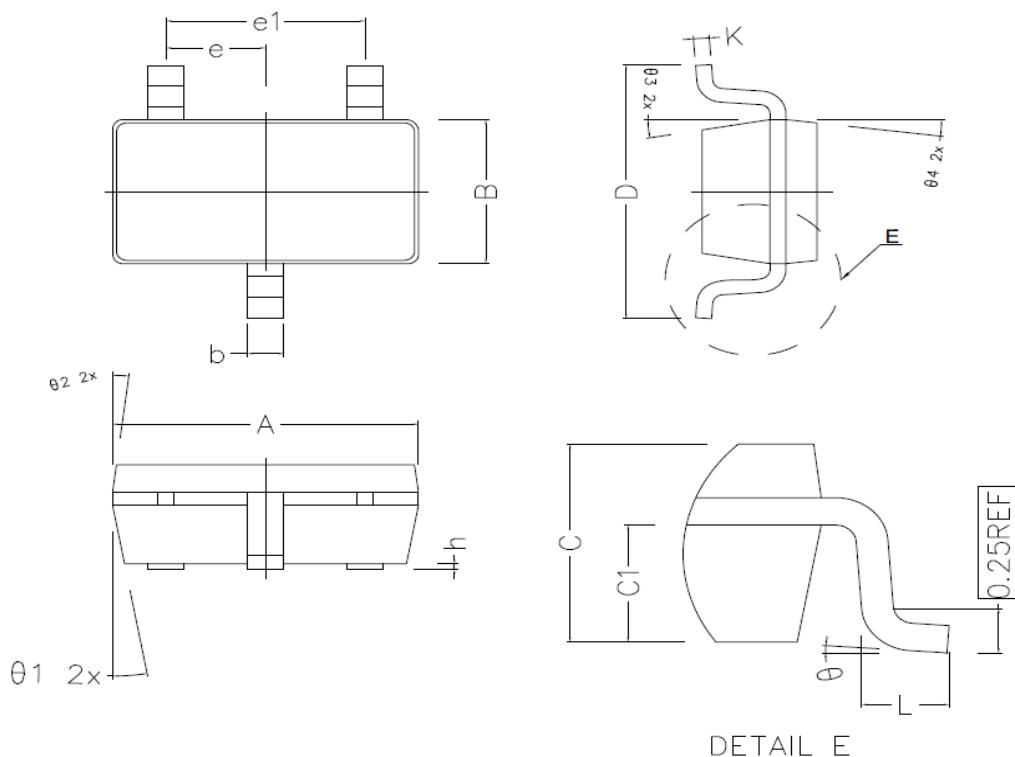
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Typical Characteristics

Figure1: TJ Junction Temperature (°C)

Figure2: -Id Drain Current (A)

Figure3: TJ Junction Temperature (°C)

Figure4: -Vds Drain-Source Voltage (V)

Figure5: -Vds Drain-Source Voltage (V)

Figure6: Qg Gate Charge (nC)

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Figure7: -Vsd Source-Drain Voltage (V)

Figure8: -Vgs Gate-Source Voltage (V)

Figure9: -Vds Drain -Source Voltage (V)

Figure10: Square Wave Pulse Duration (sec)

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Test Circuit and Waveform:

Figure A Gate Charge Test Circuit & Waveforms

Figure B Switching Test Circuit & Waveforms

Figure C Unclamped Inductive Switching Circuit & Waveforms

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SOT-23-3L Package Outline Dimensions (Units: mm)



DETAIL E

| COMMON DIMENSIONS (UNITS OF MEASURE IS mm) | | | |
|---|-----------|--------|-------|
| | MIN | NORMAL | MAX |
| A | 2.820 | 2.920 | 3.020 |
| B | 1.500 | 1.600 | 1.700 |
| C | 1.050 | 1.100 | 1.150 |
| C1 | 0.600 | 0.650 | 0.700 |
| D | 2.650 | 2.800 | 2.950 |
| L | 0.300 | 0.450 | 0.600 |
| b | 0.280 | 0.350 | 0.420 |
| h | 0.020 | 0.050 | 0.100 |
| K | 0.120 | — | 0.230 |
| e | 0.950TYPE | | |
| e1 | 1.900TYPE | | |
| θ ₁ | 10° TYPE | | |
| θ ₂ | 7° TYPE | | |
| θ ₃ | 10° TYPE | | |
| θ ₄ | 7° TYPE | | |
| θ | 0° ~ 8° | | |